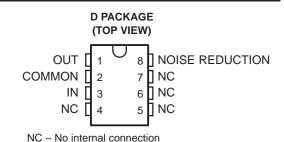
- Qualified for Automotive Applications
- 1/2 V<sub>I</sub> Virtual Ground for Analog Systems
- Micropower Operation . . . 170 μA Typ, V<sub>I</sub> = 5 V
- Wide V<sub>I</sub> Range . . . 4 V to 40 V
- High Output-Current Capability
   Source . . . 20 mA Typ
  - Sink . . . 20 mA Typ
- Excellent Output Regulation

   -102 μV Typ at I<sub>O</sub> = 0 to -10 mA
   +49 μV Typ at I<sub>O</sub> = 0 to +10 mA
- Low-Impedance Output . . . 0.0075 Ω Typ
- Noise Reduction Pin

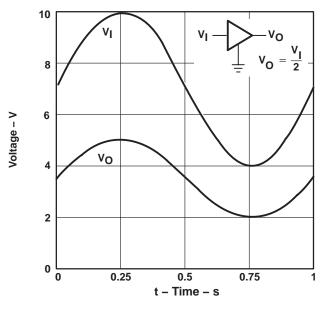
### description

In signal-conditioning applications utilizing a single power source, a reference voltage equal to one-half the supply voltage is required for termination of all analog signal grounds. Texas Instruments presents a precision virtual ground whose output voltage is always equal to one-half the input voltage, the TLE2426 *rail splitter*.

The unique combination of a high-performance, micropower operational amplifier and a precision-trimmed divider on a single silicon chip results in a precise  $V_O/V_I$  ratio of 0.5 while sinking and sourcing current. The TLE2426 provides a low-impedance output with 20 mA of sink and



#### **INPUT/OUTPUT TRANSFER CHARACTERISTICS**



source capability while drawing less than 280  $\mu$ A of supply current over the full input range of 4 V to 40 V. A designer need not pay the price in terms of board space for a conventional signal ground consisting of resistors, capacitors, operational amplifiers, and voltage references. For increased performance, the 8-pin package provides a noise-reduction pin. With the addition of an external capacitor (C<sub>NR</sub>), peak-to-peak noise is reduced while line ripple rejection is improved.

Initial output tolerance for a single 5-V or 12-V system is better than 1% over the full 40-V input range. Ripple rejection exceeds 12 bits of accuracy. Whether the application is for a data acquisition front end, analog signal termination, or simply a precision voltage reference, the TLE2426 eliminates a major source of system error.

### **ORDERING INFORMATION<sup>†</sup>**

TA	PACKA	GE‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	SOIC (D)	Tape and Reel	TLE2426QDRQ1	2426Q1

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

<sup>‡</sup> Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



## **TLE2426-Q1** THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND

SGLS252A - AUGUST 2004 - REVISED JUNE 2008

## absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

Continuous input voltage, V <sub>1</sub>	
Continuous filter trap voltage	
Output current, I <sub>O</sub>	
Duration of short-circuit current at (or below) 25°C (see Note 1)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub> : Q suffix	–40°C to 125°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D package .	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

#### **DISSIPATION RATING TABLE**

PACKAGE	T <sub>A</sub> ≤ 25°C	DERATING FACTOR	T <sub>A</sub> = 70°C	T <sub>A</sub> = 85°C	T <sub>A</sub> = 125°C
	POWER RATING	ABOVE T <sub>A</sub> = 25°C	POWER RATING	POWER RATING	POWER RATING
D	1102 mV	10.3 mW/°C	638.5 mW	484 mW	72.1 mW

#### recommended operating conditions

	MIN	MAX	UNIT
Input voltage, VI	4	40	V
Operating free-air temperature, T <sub>A</sub>	-40	125	°C



# **TLE2426-Q1** THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND SGLS252A - AUGUST 2004 - REVISED JUNE 2008

PARAMETER	TEST CONDITIO	т <sub>А</sub> †	MIN	TYP	MAX	UNIT		
	V <sub>I</sub> = 4 V		1.98	2	2.02			
	V <sub>I</sub> = 5 V	VI = 5 V			2.5	2.52	1	
Output voltage	V <sub>I</sub> = 40 V			19.8	20	20.2	V	
	V <sub>I</sub> = 5 V		Full range	2.465		2.535	1	
Temperature coefficient of output voltage		Full range		25		ppm/°C		
Quarter and the second se	No. Inc. d	VI = 5 V	25°C		170	300		
Supply current	No load	$V_I = 4$ to 40 V	Full range			400	μA	
			25°C		-0.102	±0.7		
Output voltage regulation (sourcing current) <sup>‡</sup>	$I_{O} = 0 \text{ to} - 10 \text{ mA}$	Full range			±10	mV		
(sourcing current)+	$I_{O} = 0 \text{ to} - 20 \text{ mA}$	25°C		-0.121	±1.4			
	I <sub>O</sub> = 0 to 10 mA	25°C		0.049	±0.5			
Output voltage regulation	$I_{O} = 0$ to 8 mA	Full range			±10	mV		
(sinking current) <sup>‡</sup>	I <sub>O</sub> = 0 to 20 mA	25°C		0.175	±1.4			
Output impedance <sup>‡</sup>			25°C		7.5	22.5	mΩ	
Noise-reduction impedance			25°C		110		kΩ	
	Sinking current, $V_{O} = 5 V$			26				
Short-circuit current	Sourcing current,	$V_{O} = 0$	25°C	-47			mA	
		$C_{NR} = 0$			120		μV	
Output noise voltage, rms	f = 10 Hz to 10 kHz	C <sub>NR</sub> = 1 μF	25°C		30			
		$C_L = 0$			290			
	$V_{O}$ to 0.1%, $I_{O} = \pm 10 \text{ mA}$	C <sub>L</sub> = 100 pF	25°C	275			1	
Output voltage current step response		$C_{L} = 0$ 400			μs			
	$V_{O}$ to 0.01%, $I_{O} = \pm 10 \text{ mA}$	C <sub>L</sub> = 100 pF	25°C	390				
<b>0</b> :	$V_{I} = 0 \text{ to } 5 \text{ V}, V_{O} \text{ to } 0.1\%$	C <sub>I</sub> = 100 pF			20			
Step response	$V_{I} = 0 \text{ to } 5 \text{ V}, V_{O} \text{ to } 0.01\%$	25°C	120			μs		

### electrical characteristics at specified free-air temperature, $V_I = 5 V$ , $I_O = 0$ (unless otherwise noted)

<sup>†</sup> Full range is –40°C to 125°C. <sup>‡</sup> The listed values are not production tested.



# TLE2426-Q1 THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND SGLS252A – AUGUST 2004 – REVISED JUNE 2008

# electrical characteristics at specified free-air temperature, $V_I$ = 12 V, $I_O$ = 0 (unless otherwise noted)

PARAMETER	TEST CONDITIO	T <sub>A</sub> †	MIN	TYP	MAX	UNIT		
	$V_{I} = 4 V$		1.98	2	2.02			
O de la contractione	VI = 12 V	V <sub>I</sub> = 12 V				6.05		
Output voltage	V <sub>I</sub> = 40 V			19.8	20	20.2	V	
	V <sub>I</sub> = 12 V		Full range	5.925		6.075		
Temperature coefficient of output voltage			Full range		35		ppm/°C	
		V <sub>I</sub> = 12 V	25°C		195	300		
Supply current	No load	$V_I = 4$ to 40 V	Full range			400	μA	
		-	25°C		-1.48	±10		
Output voltage regulation (sourcing current) <sup>‡</sup>	$I_{O} = 0$ to $-10$ mA	$I_{O} = 0$ to $-10$ mA				±10	mV	
(sourcing current)+	$I_{O} = 0 \text{ to} - 20 \text{ mA}$	25°C		-3.9	±10			
	I <sub>O</sub> = 0 to 10 mA	25°C		2.27	±10			
Output voltage regulation	I <sub>O</sub> = 0 to 8 mA	Full range			±10	mV		
(sinking current) <sup>‡</sup>	I <sub>O</sub> = 0 to 20 mA	25°C		4.3	±10			
Output impedance <sup>‡</sup>			25°C		7.5	22.5	mΩ	
Noise-reduction impedance			25°C		110		kΩ	
	Sinking current,	Sinking current, $V_0 = 12 V$			31			
Short-circuit current	Sourcing current,	$V_{O} = 0$	25°C		-70	mA		
		$C_{NR} = 0$			120			
Output noise voltage, rms	f = 10 Hz to 10 kHz	C <sub>NR</sub> = 1 μF	25°C	30			μV	
		$C_{L} = 0$			290		1	
	$V_{O}$ to 0.1%, $I_{O} = \pm 10 \text{ mA}$	C <sub>L</sub> = 100 pF	25°C	275				
Output voltage current step response		CL = 0		400		μs		
	$V_{O}$ to 0.01%, $I_{O} = \pm 10 \text{ mA}$	C <sub>L</sub> = 100 pF	25°C		390			
0	$V_{I} = 0$ to 12 V, $V_{O}$ to 0.1%	0 400 - 5	0500		12			
Step response	$V_{I} = 0$ to 12 V, $V_{O}$ to 0.01%	C <sub>L</sub> = 100 pF	25°C		120	μs		

<sup>†</sup> Full range is -40°C to 125°C.
<sup>‡</sup> The listed values are not production tested.



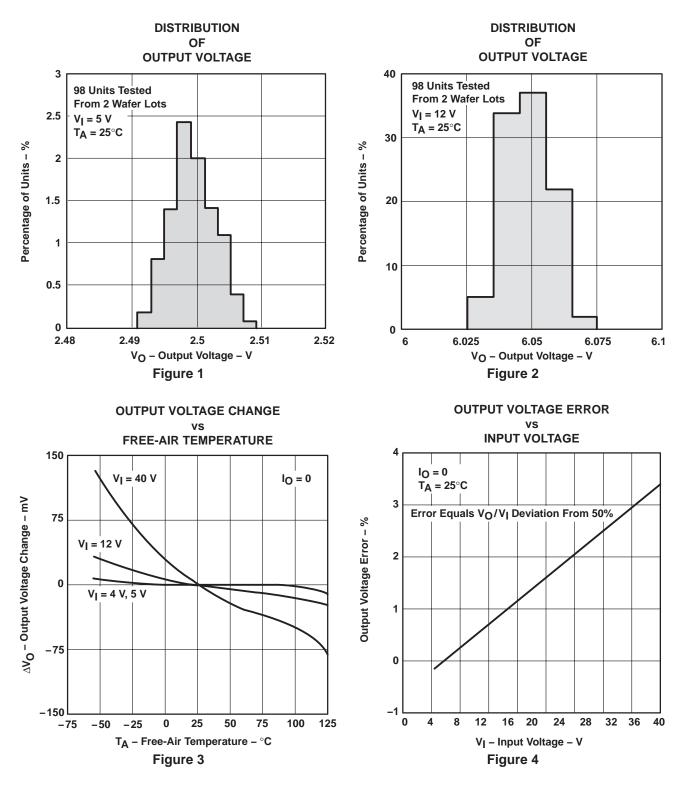
## **TYPICAL CHARACTERISTICS**

## **Table Of Graphs**

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Chart size it autout aurorat	vs Input voltage	9, 10
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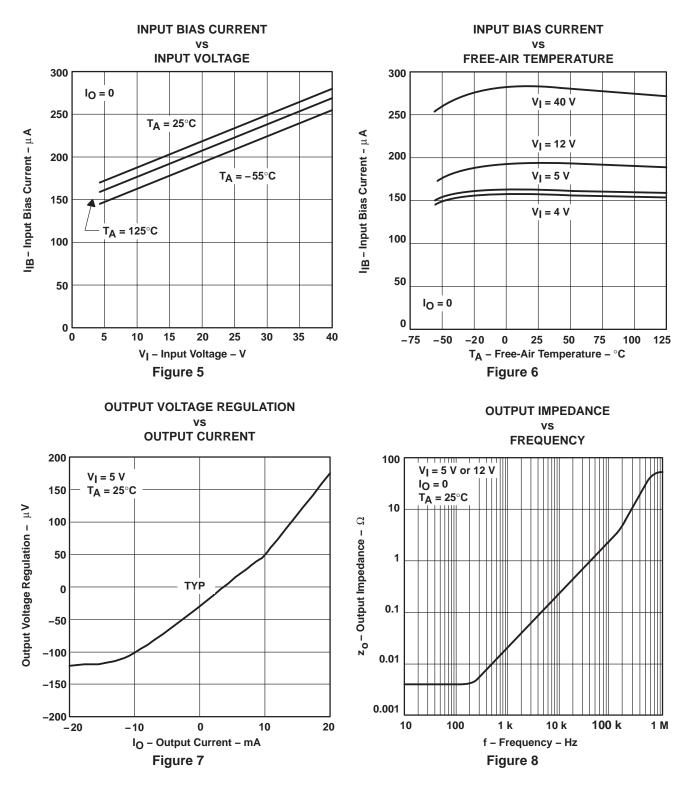
## **TYPICAL CHARACTERISTICS<sup>†</sup>**



<sup>†</sup> Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



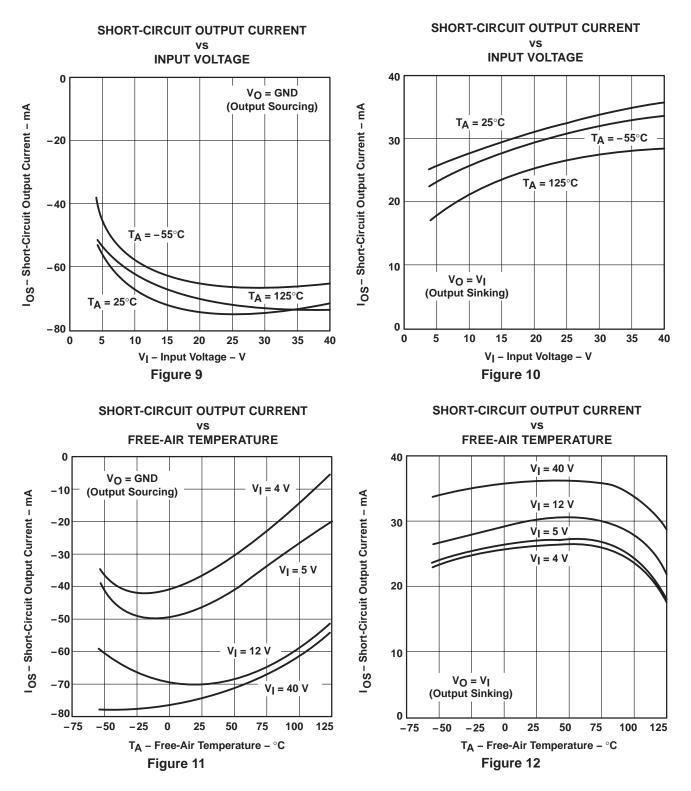
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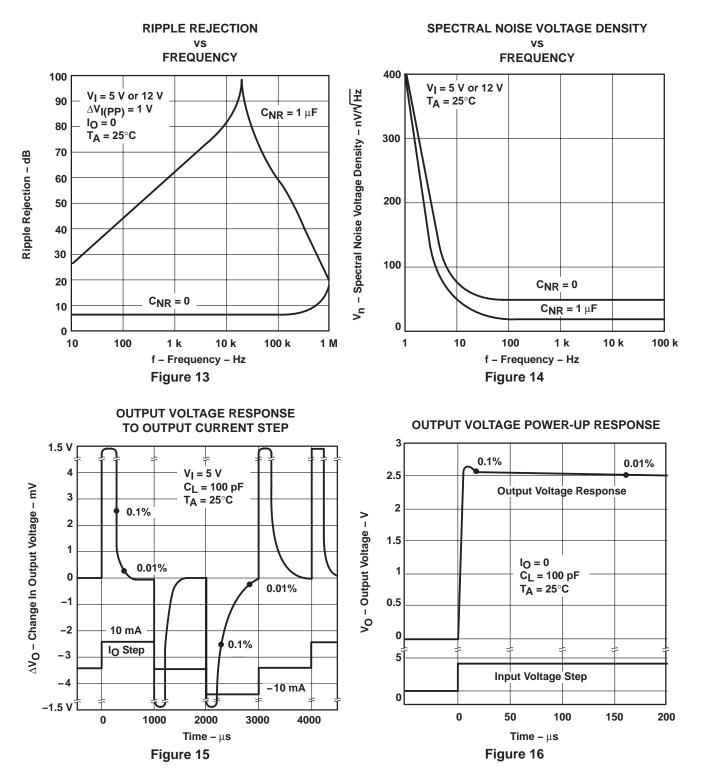
## **TYPICAL CHARACTERISTICS<sup>†</sup>**



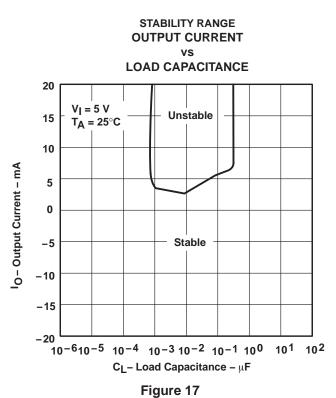
<sup>†</sup> Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



## **TYPICAL CHARACTERISTICS**







#### **TYPICAL CHARACTERISTICS**



# TLE2426-Q1 THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND SGLS252A - AUGUST 2004 - REVISED JUNE 2008

### **MACROMODEL INFORMATION**

*	TLE2426 OPERATIONAL AMPLIFIER "MACROMODEL" SUBCIRCUIT
*	CREATED USING PARTS RELEASE 4.03 ON 08/21/90 AT 13:51
*	REV (N/A) SUPPLY VOLTAGE: 5 V
*	CONNECTIONS: FILTER
	INPUT
*	COMMON
*	OUTPUT
*	
.st	JBCKT TLE2426 1 3 4 5

C1 C2 C3 DCM+ DCM- DC DE DLP DLN DP ECMR EGND EPSR ENSE FB GA	6 85 81 83 54 90 92 84 995 85 89	7 86 82 81 53 5 91 90 3 99 0 2 99	DX DX DX DX DX DX (2,99) 1 POLY(2)	(3,4) (88,0) VB VC	-16.22 120E-	2E-6 61	.5 .5 3.24E- IVPSR 0	6 74.8E6 -	10E6 10	DE6 10	E6	-10E6	74E6
GCM	0		10 99 1.0										
GPSR			(85,86)	100E-6	5								
GRC1 GRC2	4 4	11 12	(4,11) 3.2 (4,12) 3.2										
GRE1			(13,10)	1.038E	- 3								
GRE2	14	10	(14,10)	1.038E	- 3								
HLIM	90		VLIM 1K	TICM	TICM	0	1 10	1 80					
HCMR IRP	80 3		POLY(2) 146E-6	VCM+	VCM-	0	1E2	1E2					
IEE	3		DC 24.05E	- 6									
IIO	2		.2E-9										
I1	88		1E-21										
Q1			13 QX										
Q2 R2	12 6		14 QX 100.0E3										
RCM		81											
REE	10	99	8.316E6										
RN1	87	0	2.55E8										
RN2			11.67E3										
RO1 RO2	8 7		63 62										
VCM +			1.0										
VCM-			-2.3										
VB	9		DC 0										
VC	3		DC 1.400										
VE VLIM	54 7		DC 1.400 DC 0										
VLP	, 91		DC 30										
VLN		92	DC 30										
VPSR			DC 0										
RFB RIN1	5 3		1K 220K										
RIN1 RIN2	3 1		220K 220K										
			00.OE-18)										
	PNI	P(IS	=800.OE-18	BF=480	)								
.ENDS													



### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLE2426QDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2426QDRQ1	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF TLE2426-Q1 :

- Catalog: TLE2426
- Enhanced Product: TLE2426-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AA.



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